MOSFET - Power, Single N-Channel, TOLL

60 V, 0.9 mΩ, 422 A

NVBLS001N06C

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- Lowers Switching Noise/EMI
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX		
60 V	$0.9~\mathrm{m}\Omega$ @ 10 V	422 A		

MAXIMUM RATINGS (T _J = 25°C unless otherwise noted)							
Parameter			Symbol	Value	Unit		
Drain-to-Source Voltage			V _{DSS}	60	V		
Gate-to-Source Voltage	ate-to-Source Voltage			±20	V		
Continuous Drain		$T_{C} = 25^{\circ}C$	I _D	422	А		
Current $R_{\theta JC}$ (Note 2)	Steady	$T_{C} = 100^{\circ}C$		298			
Power Dissipation	State	$T_{C} = 25^{\circ}C$	PD	284	W		
R _{θJC} (Note 2)		$T_{C} = 100^{\circ}C$		142			
Continuous Drain	Steady State	T _A = 25°C	Ι _D	51	А		
Current R _{θJA} (Notes 1, 2)		$T_A = 100^{\circ}C$		36			
Power Dissipation		T _A = 25°C	PD	4.2	W		
R _{θJA} (Notes 1, 2)		$T_A = 100^{\circ}C$		2.1			
Pulsed Drain Current	$T_A = 25^{\circ}C$, $t_p = 10 \ \mu s$		I _{DM}	900	А		
Operating Junction and Storage Temperature Range Source Current (Body Diode)			T _J , T _{stg}	–55 to +175	°C		
			۱ _S	236	А		
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 39 A)			E _{AS}	1640	mJ		
Lead Temperature Soldering Reflow for Solder- ing Purposes (1/8" from case for 10 s)			ΤL	260	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

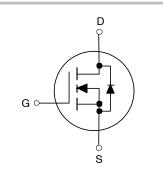
THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2)	$R_{\theta JC}$	0.53	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	36	

1. Surface-mounted on FR4 board using a 1 in² pad size, 2 oz. Cu pad.

2. The entire application environment impacts the thermal resistance values shown,

they are not constants and are only valid for the particular conditions noted.





CASE 100CU

ORDERING INFORMATION

Device	Package	Shipping [†]
NVBLS001N06C	H-PSOF8L (Pb-Free)	2000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

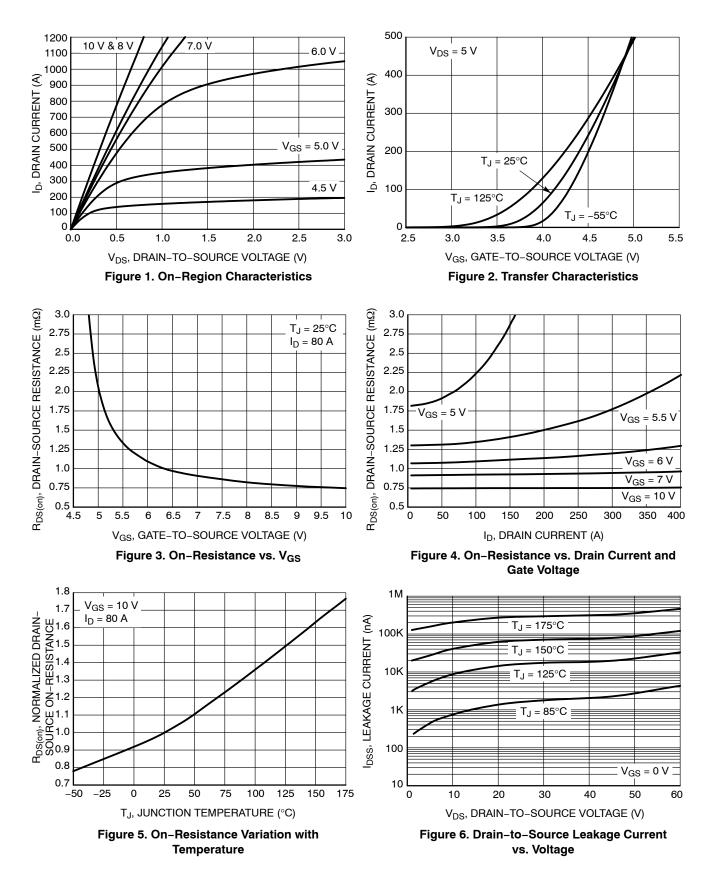
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Table 1. ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

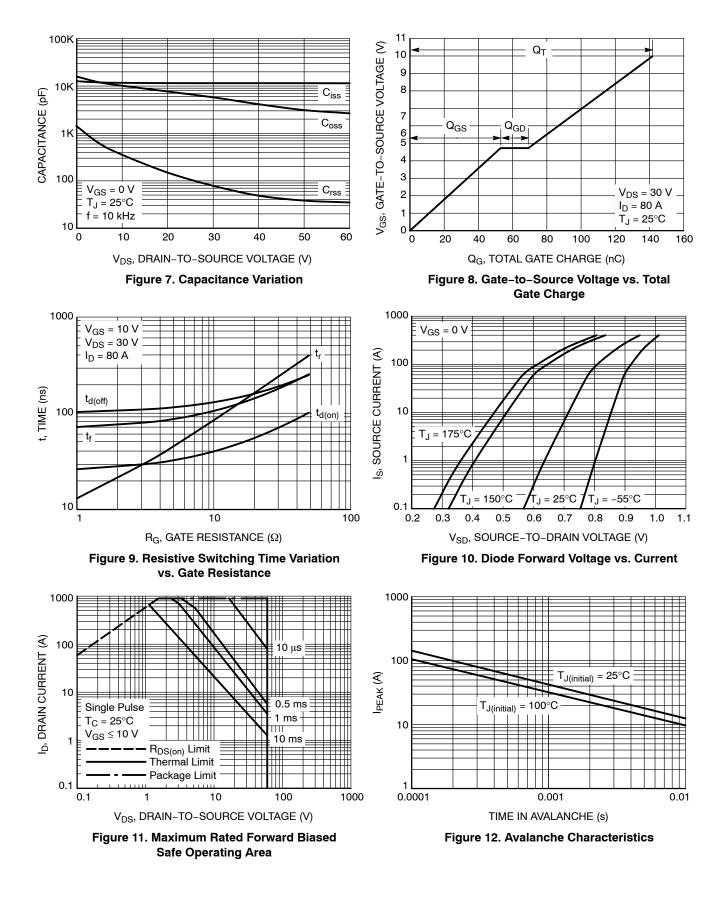
Parameter	Symbol	Test Conditions		Min	Тур	Max	Units
OFF CHARACTERISTICS	•	-		*		-	-
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	$I_D = 562 \ \mu\text{A}, \text{ ref to } 25^\circ\text{C}$			26		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	T _J = 25°C T _J = 125°C			10 100	μΑ μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS} = 20 V$				100	nA
ON CHARACTERISTICS (Note 3)	-466	103 11,10			I		
Gate Threshold Voltage	V _{GS(th)}	V _{GS} = V _{DS} , I _D	= 562 μA	2.0	2.8	4.0	V
Negative Threshold Temperature Coefficient	V _{GS(th)} /T _J	l _D = 562 μA, r	•		9.9		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V,		1	0.75	0.9	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 5 V, I	_D = 80 A		290		S
CHARGES & CAPACTIANCES		L					
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 30 V, f = 10 kHz			11575		pF
Output Capacitance	C _{oss}				5973		pF
Reverse Transfer Capacitance	C _{rss}				76		pF
Total Gate Charge	Q _{G(tot)}	$V_{GS} = 10 \text{ V}, \text{ V}_{DS} = 30 \text{ V},$ $I_D = 80 \text{ A}$			143		nC
Threshold Gate Charge	Q _{G(th)}				31		nC
Gate-to-Source Charge	Q _{gs}				54		nC
Gate-to-Drain Charge	Q _{gd}	1			13		nC
SWITCHING CHARACTERISTICS, $V_{GS} = 1$	0 V (Note 3)						
Turn-On Delay Time	t _{d(on)}	V_{GS} = 10 V, V_{DS} = 30 V, I_{D} = 80 A, R_{G} = 6 Ω			34		ns
Rise Time	t _r				53		ns
Turn-Off Delay Time	t _{d(off)}				119		ns
Fall Time	t _f				91		ns
DRAIN-SOURCE DIODE CHARACTERIST	CS						
Forward Diode Voltage	V _{SD}	$I_{\rm S}$ = 80 A, $V_{\rm GS}$ = 0 V	$T_J = 25^{\circ}C$		0.79	1.2	V
		$I_{\rm S}$ = 80 A, $V_{\rm GS}$ = 0 V	$T_J = 125^{\circ}C$		0.66		V
Reverse Recovery Time	t _{rr}	V_{GS} = 0 V, dI_S/d_t = 100 A/µs, I_S = 56 A			120		ns
Charge Time	t _a				60		ns
Discharge Time	t _b				60		ns
Reverse Recovery Charge	Q _{rr}				322		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Switching characteristics are independent of operating junction temperatures

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

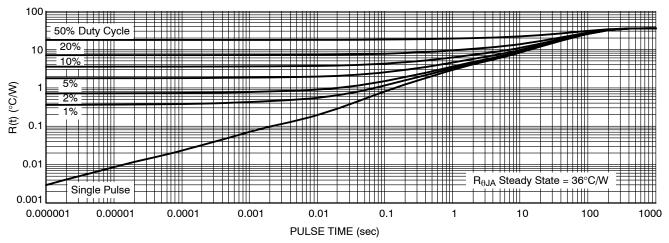
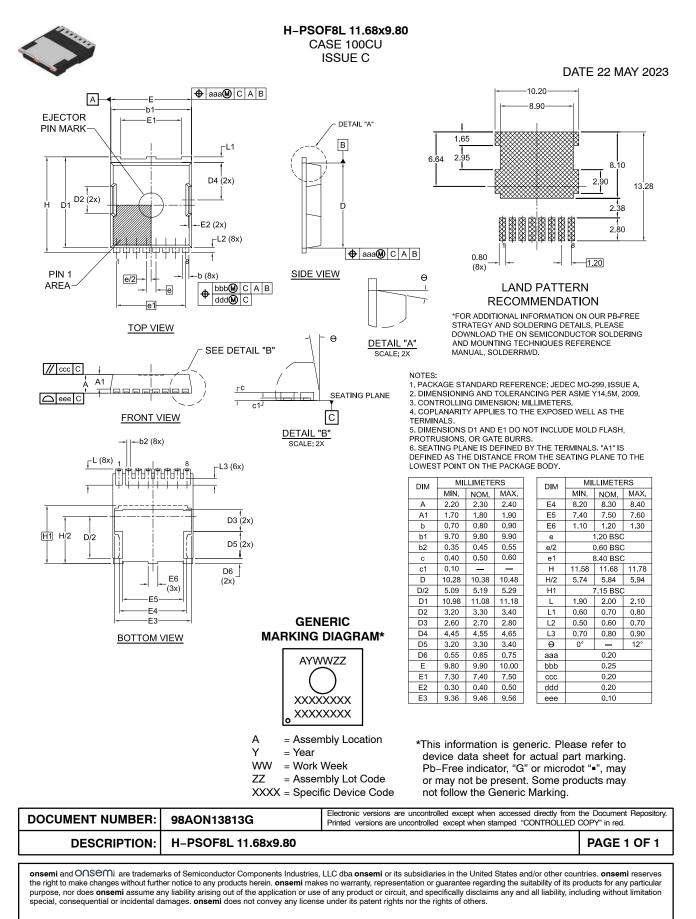


Figure 13. Thermal Characteristics (Junction-to-Ambient)

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